



Layer	Name	Material	Thickness	Constant
	Top Overlay			
	Top Solder	SM-001	1.00mil	4
	Top Surface Finish	PbSn	0.79mil	
1	Top Layer	CF-004	1.38mil	
	Dielectric 1	Core-043	59.00mil	4.3
2	Bottom Layer	CF-004	1.38mil	
	Bottom Surface Finish	PbSn	0.79mil	
	Bottom Solder	SM-001	1.00mil	4
	Bottom Overlay			

Total board thickness: 65.33mil

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape
☆	137	0.300mm (11.81mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
✧	31	0.500mm (19.69mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
▽	4	1.100mm (43.31mil)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)
□	2	3.200mm (125.98mil)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded
	174 Total						





